

05-03-2004

Attorney Docket No. 8053-1019

Form PTO-1595

RECO

U.S. Department of Commerce
U.S. Patent and Trademark Office

4-28-04



102735339

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of Conveying Party(ies):
Hitoshi NINOMIYA

Additional name(s) of conveying party(ies) attached?
 Yes No

2. Name and address of receiving party(ies)
 Name: **NEC Electronics Corporation**
 Address: **1753 Shimonumabe, Nakahara-ku
Kawasaki-shi, Kanagawa, Japan**

17548 U.S. PTO
10/833055

042804

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other: _____
 Execution Date: **April 16, 2004**

Additional name(s) and address(es) attached?
 Yes No

4. Application number(s) or patent number(s): **10833055**

This document is being filed with a new application, the execution date of the application is: **April 16, 2004**

A. Patent Application No(s). B. Patent No(s).

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Customer No.: 00466
YOUNG & THOMPSON
Second Floor
745 South 23rd Street
Arlington, VA 22202
Phone: 703-521-2297
Fax: 703-685-0573

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41)..... **\$40.00**
 Enclosed
 Authorized to be charged to deposit account

8. Deposit Account No. **25-0120**
 (Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Benoit Castel *Benoit Castel* **April 28, 2004**
 Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and documents: **2**

RECORDED 10833055
40.00

Y&T March 7, 2004

PATENT
REEL: 015270 FRAME: 0824

ASSIGNMENT

WHEREAS, HITOSHI NINOMIYA of Kanagawa, Japan

has invented certain new and useful improvements in SEMICONDUCTOR DEVICE, AND PRODUCTION METHOD FOR MANUFACTURING SUCH SEMICONDUCTOR DEVICE

for which I am about to make application for Letters (I/we have made—or am/are about to make)

Patent of the United States of America;

AND WHEREAS, NEC Electronics Corporation, 1753 Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan is

desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the United States;

NOW THEREFORE, be it known by all whom it may concern, that for and in consideration of

One Dollars (\$ 1.00)

to me in hand paid, the receipt of which is hereby acknowledged the said ASSIGNOR

have assigned, sold, and set over, and by these presents do hereby assign, sell, and set over unto the said

ASSIGNEE, NEC Electronics Corporation

* the full and exclusive right, title, and interest in and to the said invention,

as fully set forth and described in the:

Delete inapplicable wording

(a) specification prepared and executed by me on the 16-th day of April, 2004,

(b) application filed on the day of , Serial No. ,

preparatory to obtaining Letters Patent therefor; said invention, application and Letters Patent to be

held and enjoyed by the said ASSIGNEE, NEC Electronics Corporation


for their own use and behoof, and for their legal representatives, to the full end of the term

for which said Letters Patent are granted, as fully and entirely as the same would have been held by

me had this assignment and sale not been made.

IN TESTIMONY WHEREOF, I hereunto set my hand and affix my seal at

Kanagawa, Japan this 16-th day of April, A.D. 2004.

Hitoshi Ninomiya (Inventor's full Signature)  HITOSHI NINOMIYA

Witness:

Hitoshi Ukai HITOSHI UKAI

Akira Muto AKIRA MUTO